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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	ST7
Core Size	8-Bit
Speed	8MHz
Connectivity	SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	32
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3.8V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/stmicroelectronics/st72f324bj6t6

Table 3. Hardware register map (continued)

Address	Block	Register label	Register name	Reset status(1)	Remarks(1)
000Fh 0010h 0011h	Port F(1)	PFDR PFDDR PFOR	Port F data register Port F data direction register Port F option register	00h(2) 00h 00h	R/W R/W R/W
0012h to 0020h	Reserved area (15 bytes)				
0021h 0022h 0023h	SPI	SPIDR SPICR SPICSR	SPI data I/O register SPI control register SPI control/status register	xxh 0xh 00h	R/W R/W R/W
0024h 0025h 0026h 0027h	ITC	ISPR0 ISPR1 ISPR2 ISPR3	Interrupt software priority register 0 Interrupt software priority register 1 Interrupt software priority register 2 Interrupt software priority register 3	FFh FFh FFh FFh	R/W R/W R/W R/W
0028h		EICR	External interrupt control register	00h	R/W
0029h	Flash	FCSR	Flash control/status register	00h	R/W
002Ah	Watchdog	WDGCR	Watchdog control register	7Fh	R/W
002Bh	SI	SICSR	System integrity control/status register	000x 000xb	R/W
002Ch 002Dh	MCC	MCCSR MCCBCR	Main clock control/status register Main clock controller: beep control register	00h 00h	R/W R/W
002Eh to 0030h	Reserved area (3 bytes)				
0031h 0032h 0033h 0034h 0035h 0036h 0037h 0038h 0039h 003Ah 003Bh 003Ch 003Dh 003Eh 003Fh	Timer A	TACR2 TACR1 TACSR TAIC1HR TAIC1LR TAOC1HR TAOC1LR TACHR TACLR TAACHR TAACLR TAIC2HR TAIC2LR TAOC2HR TAOC2LR	Timer A control register 2 Timer A control register 1 Timer A control/status register Timer A input capture 1 high register Timer A input capture 1 low register Timer A output compare 1 high register Timer A output compare 1 low register Timer A counter high register Timer A counter low register Timer A alternate counter high register Timer A alternate counter low register Timer A input capture 2 high register Timer A input capture 2 low register Timer A output compare 2 high register Timer A output compare 2 low register	00h 00h xxxx x0xxb xxh xxh 80h 00h FFh FCh FFh FCh xxh xxh 80h 00h	R/W R/W R/W Read only Read only R/W R/W Read only Read only Read only Read only Read only Read only R/W R/W
0040h	Reserved area (1 byte)				

5.3.1 Accumulator (A)

The Accumulator is an 8-bit general purpose register used to hold operands and the results of the arithmetic and logic calculations and to manipulate data.

5.3.2 Index registers (X and Y)

These 8-bit registers are used to create effective addresses or as temporary storage areas for data manipulation. (The Cross-Assembler generates a precede instruction (PRE) to indicate that the following instruction refers to the Y register.)

The Y register is not affected by the interrupt automatic procedures.

5.3.3 Program counter (PC)

The program counter is a 16-bit register containing the address of the next instruction to be executed by the CPU. It is made of two 8-bit registers PCL (Program Counter Low which is the LSB) and PCH (Program Counter High which is the MSB).

5.3.4 Condition Code register (CC)

The 8-bit Condition Code register contains the interrupt masks and four flags representative of the result of the instruction just executed. This register can also be handled by the PUSH and POP instructions. These bits can be individually tested and/or controlled by specific instructions.

CC Reset value: 111x1xxx

7	6	5	4	3	2	1	0
1	1	I1	H	I0	N	Z	C
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Table 6. Arithmetic management bits

Bit	Name	Function
4	H	Half carry This bit is set by hardware when a carry occurs between bits 3 and 4 of the ALU during an ADD or ADC instructions. It is reset by hardware during the same instructions. 0: No half carry has occurred. 1: A half carry has occurred. This bit is tested using the JRH or JRNH instruction. The H bit is useful in BCD arithmetic subroutines.
2	N	Negative This bit is set and cleared by hardware. It is representative of the result sign of the last arithmetic, logical or data manipulation. It is a copy of the result 7th bit. 0: The result of the last operation is positive or null. 1: The result of the last operation is negative (that is, the most significant bit is a logic 1. This bit is accessed by the JRMI and JRPL instructions.

6.6 SI registers

6.6.1 System integrity (SI) control/status register (SICSR)

SICSR Reset value: 000x 000x (00h)

7	6	5	4	3	2	1	0
Res	AVDIE	AVDF	LVDRF	Reserved			WDGRF
-	R/W	RO	R/W	-			R/W

Table 12. SICSR register description

Bit	Name	Function
7	-	Reserved, must be kept cleared
6	AVDIE	Voltage Detector Interrupt Enable This bit is set and cleared by software. It enables an interrupt to be generated when the AVDF flag changes (toggles). The pending interrupt information is automatically cleared when software enters the AVD interrupt routine 0: AVD interrupt disabled 1: AVD interrupt enabled
5	AVDF	Voltage Detector Flag This read-only bit is set and cleared by hardware. If the AVDIE bit is set, an interrupt request is generated when the AVDF bit changes value. Refer to *Figure 15* and to *Section 6.5.2: AVD (auxiliary voltage detector)* for additional details. 0: V_{DD} over $V_{IT+(AVD)}$ threshold 1: V_{DD} under $V_{IT-(AVD)}$ threshold
4	LVDRF	LVD Reset Flag This bit indicates that the last reset was generated by the LVD block. It is set by hardware (LVD reset) and cleared by software (writing zero). See WDGRF flag description for more details. When the LVD is disabled by option byte, the LVDRF bit value is undefined.
3:1	-	Reserved, must be kept cleared
0	WDGRF	Watchdog Reset Flag This bit indicates that the last reset was generated by the Watchdog peripheral. It is set by hardware (watchdog reset) and cleared by software (writing zero) or an LVD reset (to ensure a stable cleared state of the WDGRF flag when CPU starts). Combined with the LVDRF information, the flag description is given in *Table 13*.

Table 13. Reset source flags

Reset sources	LVDRF	WDGRF
External $\overline{\text{RESET}}$ pin	0	0
Watchdog	0	1
LVD	1	X

7.6 External interrupts

7.6.1 I/O port interrupt sensitivity

The external interrupt sensitivity is controlled by the IPA, IPB and ISxx bits of the EICR register (*Figure 20*). This control allows up to four fully independent external interrupt source sensitivities.

Each external interrupt source can be generated on four (or five) different events on the pin:

- Falling edge
- Rising edge
- Falling and rising edge
- Falling edge and low level
- Rising edge and high level (only for ei0 and ei2)

To guarantee correct functionality, the sensitivity bits in the EICR register can be modified only when the I1 and I0 bits of the CC register are both set to 1 (level 3). This means that interrupts must be disabled before changing sensitivity.

The pending interrupts are cleared by writing a different value in the ISx[1:0], IPA or IPB bits of the EICR.

Figure 20. External interrupt control bits

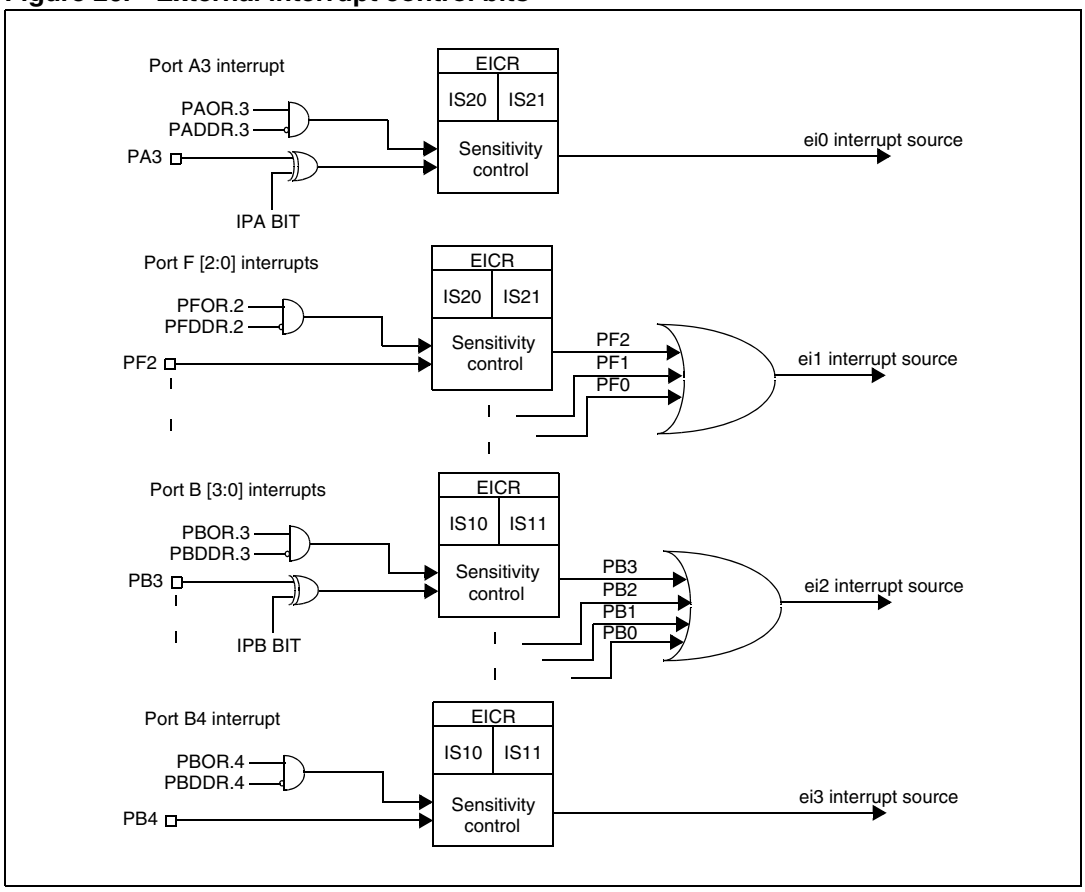


Table 25. Interrupt mapping

No.	Source block	Description	Register label	Priority order	Exit from Halt/Active Halt	Address vector
	Reset	Reset	N/A		yes	FFFEh-FFFFh
	TRAP	Software interrupt			no	FFFCh-FFFDh
0	Not used					FFFAh-FFFBh
1	MCC/RTC	Main clock controller time base interrupt	MCCSR	Higher priority	yes	FFF8h-FFF9h
2	ei0	External interrupt port A3..0	N/A		yes	FFF6h-FFF7h
3	ei1	External interrupt port F2..0			yes	FFF4h-FFF5h
4	ei2	External interrupt port B3..0			yes	FFF2h-FFF3h
5	ei3	External interrupt port B7..4			yes	FFF0h-FFF1h
6	Not used					FFEEh-FFEFh
7	SPI	SPI peripheral interrupts	SPICSR		yes	FFECh-FFEDh
8	Timer A	Timer A peripheral interrupts	TASR		no	FFEAh-FFEBh
9	Timer B	Timer B peripheral interrupts	TBSR		no	FFE8h-FFE9h
10	SCI	SCI peripheral interrupts	SCISR	Lower priority	no	FFE6h-FFE7h
11	AVD	Auxiliary voltage detector interrupt	SICSR		no	FFE4h-FFE5h

9 I/O ports

9.1 Introduction

The I/O ports offer different functional modes:

- transfer of data through digital inputs and outputs,

and for specific pins:

- external interrupt generation,
- alternate signal input/output for the on-chip peripherals.

An I/O port contains up to 8 pins. Each pin can be programmed independently as digital input (with or without interrupt generation) or digital output.

9.2 Functional description

Each port has two main registers:

- Data Register (DR)
- Data Direction Register (DDR)

and one optional register:

- Option Register (OR)

Each I/O pin may be programmed using the corresponding register bits in the DDR and OR registers: bit X corresponding to pin X of the port. The same correspondence is used for the DR register.

The following description takes into account the OR register, (for specific ports which do not provide this register refer to *Section 9.3: I/O port implementation on page 62*). The generic I/O block diagram is shown in *Figure 28.*

9.2.1 Input modes

The input configuration is selected by clearing the corresponding DDR register bit.

In this case, reading the DR register returns the digital value applied to the external I/O pin.

Different input modes can be selected by software through the OR register.

Note: 1 Writing the DR register modifies the latch value but does not affect the pin status.

2 When switching from input to output mode, the DR register has to be written first to drive the correct level on the pin as soon as the port is configured as an output.

3 Do not use read/modify/write instructions (BSET or BRES) to modify the DR register as this might corrupt the DR content for I/Os configured as input.

Table 39. MCCSR register description (continued)

Bit	Name	Function
6:5	CP[1:0]	CPU Clock Prescaler These bits select the CPU clock prescaler which is applied in different slow modes. Their action is conditioned by the setting of the SMS bit. These two bits are set and cleared by software: 00: f_{CPU} in Slow mode = $f_{OSC2}/2$ 01: f_{CPU} in Slow mode = $f_{OSC2}/4$ 10: f_{CPU} in Slow mode = $f_{OSC2}/8$ 11: f_{CPU} in Slow mode = $f_{OSC2}/16$
4	SMS	Slow Mode Select This bit is set and cleared by software. 0: Normal mode. $f_{CPU} = f_{OSC2}$. 1: Slow mode. f_{CPU} is given by CP1, CP0. See *Section 8.2: Slow mode* and *Section 10.2: Main clock controller with real-time clock and beeper (MCC/RTC)* for more details.
3:2	TB[1:0]	Time Base control These bits select the programmable divider time base. They are set and cleared by software (see *Table 40*). A modification of the time base is taken into account at the end of the current period (previously set) to avoid an unwanted time shift. This allows to use this time base as a real-time clock.
1	OIE	Oscillator interrupt Enable This bit set and cleared by software. 0: Oscillator interrupt disabled 1: Oscillator interrupt enabled This interrupt can be used to exit from Active Halt mode. When this bit is set, calling the ST7 software HALT instruction enters the Active Halt power saving mode.
0	OIF	Oscillator interrupt Flag This bit is set by hardware and cleared by software reading the MCCSR register. It indicates when set that the main oscillator has reached the selected elapsed time (TB1:0). 0: Timeout not reached 1: Timeout reached **Caution**: The BRES and BSET instructions must not be used on the MCCSR register to avoid unintentionally clearing the OIF bit.

Table 40. Time base selection

Counter prescaler	Time base		TB1	TB0
	f_{OSC2} = 4 MHz	f_{OSC2} = 8 MHz		
16000	4ms	2ms	0	0
32000	8ms	4ms	0	1
80000	20ms	10ms	1	0
200000	50ms	25ms	1	1

Input capture

In this section, the index, *i*, may be 1 or 2 because there are two input capture functions in the 16-bit timer.

The two 16-bit input capture registers (IC1R/IC2R) are used to latch the value of the free running counter after a transition is detected on the ICAP*i* pin (see *Figure 40*).

Table 44. Input capture byte distribution

Register	MS byte	LS byte
ICiR	IC*i*HR	IC*i*LR

The ICiR registers are read-only registers.

The active transition is software programmable through the IEDG*i* bit of Control Registers (CR*i*).

Timing resolution is one count of the free running counter: (f_{CPU}/CC[1:0]).

Procedure

To use the input capture function select the following in the CR2 register:

- Select the timer clock (CC[1:0]) (see *Table 50*).
- Select the edge of the active transition on the ICAP2 pin with the IEDG2 bit (the ICAP2 pin must be configured as floating input or input with pull-up without interrupt if this configuration is available).

Select the following in the CR1 register:

- Set the ICIE bit to generate an interrupt after an input capture coming from either the ICAP1 pin or the ICAP2 pin
- Select the edge of the active transition on the ICAP1 pin with the IEDG1 bit (the ICAP1pin must be configured as floating input or input with pull-up without interrupt if this configuration is available).

When an input capture occurs:

- ICF*i* bit is set.
- The IC*i*R register contains the value of the free running counter on the active transition on the ICAP*i* pin (see *Figure 40*).
- A timer interrupt is generated if the ICIE bit is set and the I bit is cleared in the CC register. Otherwise, the interrupt remains pending until both conditions become true.

Clearing the Input Capture interrupt request (that is, clearing the ICF*i* bit) is done in two steps:

1. Reading the SR register while the ICF*i* bit is set
2. An access (read or write) to the IC*i*LR register

Note: 1 After reading the ICiHR register, transfer of input capture data is inhibited and ICFi will never be set until the ICiLR register is also read.

2 The ICiR register contains the free running counter value which corresponds to the most recent input capture.

3 The two input capture functions can be used together even if the timer also uses the two output compare functions.

4 In One pulse mode and PWM mode only Input Capture 2 can be used.

5 The alternate inputs (ICAP1 and ICAP2) are always directly connected to the timer. So any transitions on these pins activates the input capture function.
Moreover if one of the ICAPi pins is configured as an input and the second one as an output, an interrupt can be generated if the user toggles the output pin and if the ICIE bit is set.
This can be avoided if the input capture function i is disabled by reading the ICiHR (see note 1).

6 The TOF bit can be used with interrupt generation in order to measure events that go beyond the timer range (FFFFh).

Figure 39. Input capture block diagram

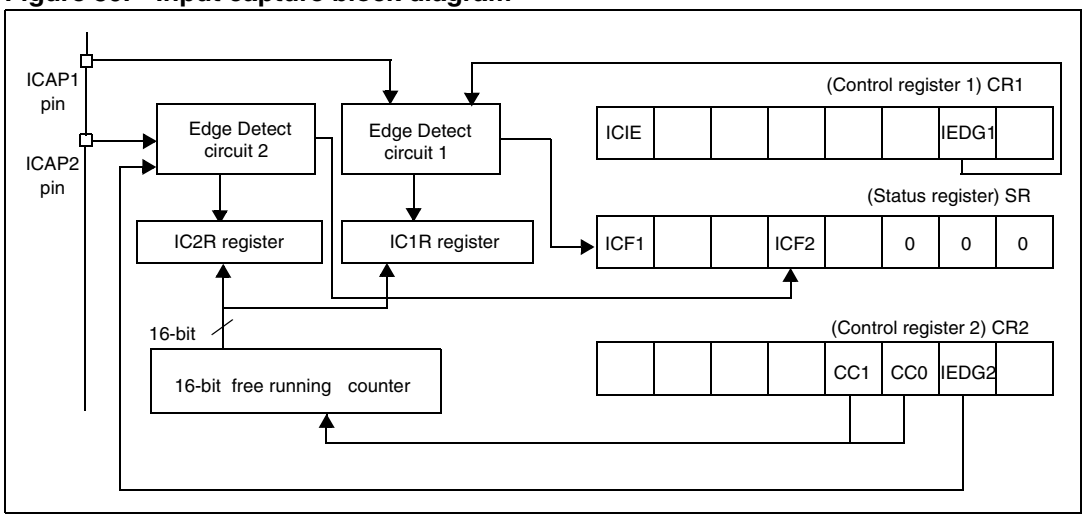
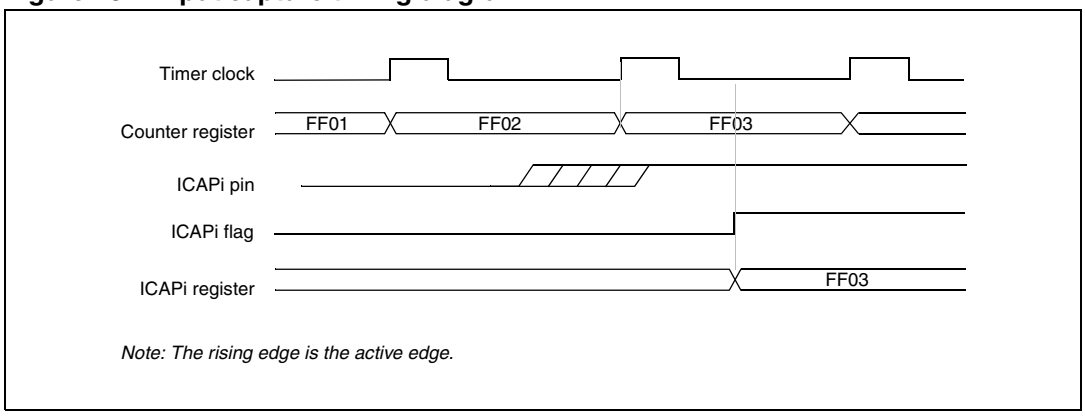


Figure 40. Input capture timing diagram



Note: The rising edge is the active edge.

Figure 41. Output compare block diagram

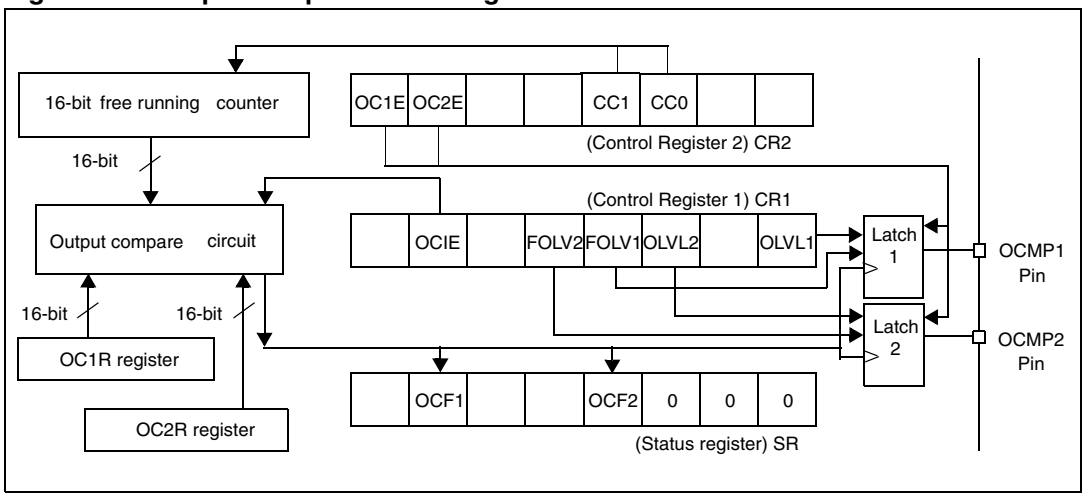


Figure 42. Output compare timing diagram, $f_{TIMER} = f_{CPU}/2$

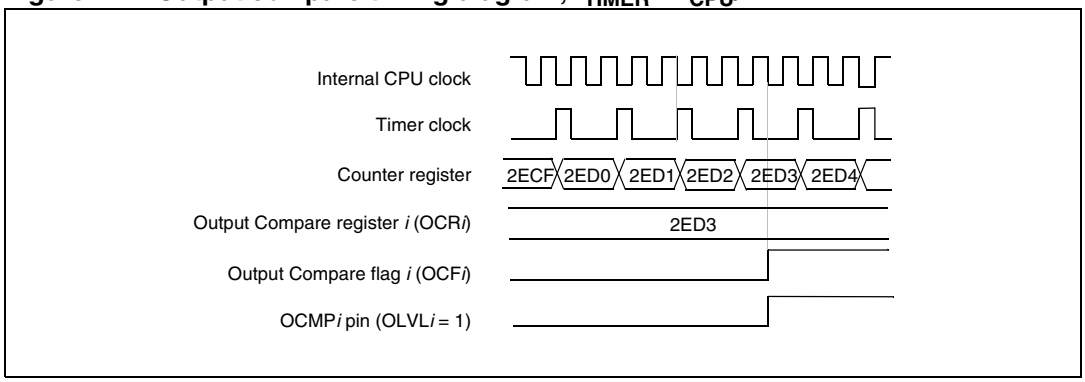


Figure 43. Output compare timing diagram, $f_{TIMER} = f_{CPU}/4$

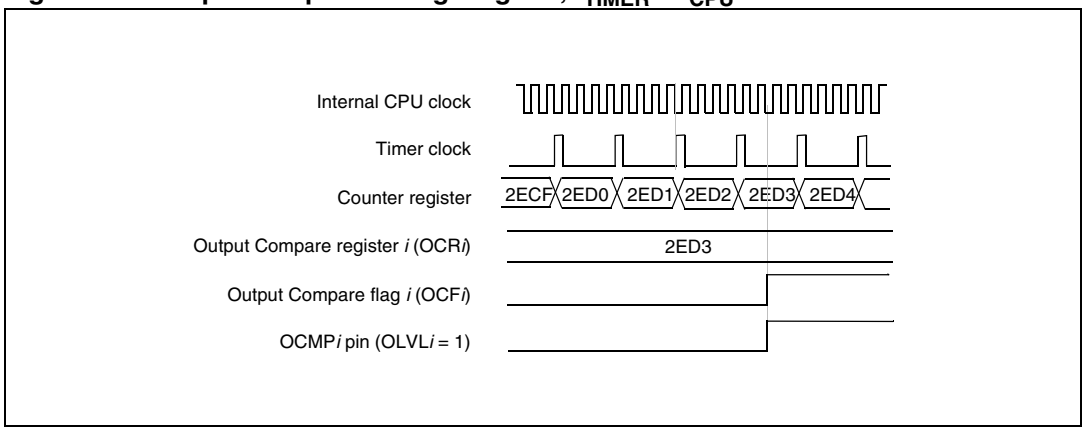
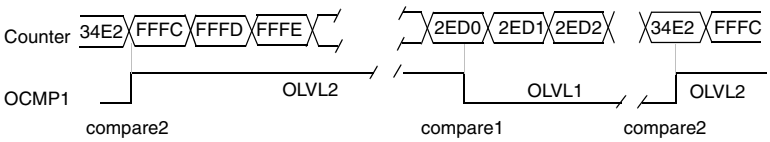


Figure 46. Pulse width modulation mode timing example with two output compare functions(1)(2)



1. OC1R = 2ED0h, OC2R = 34E2, OLVL1 = 0, OLVL2 = 1
2. On timers with only one Output Compare register, a fixed frequency PWM signal can be generated using the output compare and the counter overflow to define the pulse length.

Pulse Width Modulation mode

Pulse Width Modulation (PWM) mode enables the generation of a signal with a frequency and pulse length determined by the value of the OC1R and OC2R registers.

Pulse Width Modulation mode uses the complete Output Compare 1 function plus the OC2R register, and so this functionality can not be used when PWM mode is activated.

In PWM mode, double buffering is implemented on the output compare registers. Any new values written in the OC1R and OC2R registers are taken into account only at the end of the PWM period (OC2) to avoid spikes on the PWM output pin (OCMP1).

Procedure

To use Pulse Width Modulation mode:

1. Load the OC2R register with the value corresponding to the period of the signal using the formula below.
2. Load the OC1R register with the value corresponding to the period of the pulse if (OLVL1 = 0 and OLVL2 = 1) using the formula in the opposite column.
3. Select the following in the CR1 register:
   - Using the OLVL1 bit, select the level to be applied to the OCMP1 pin after a successful comparison with the OC1R register.
   - Using the OLVL2 bit, select the level to be applied to the OCMP1 pin after a successful comparison with the OC2R register.
4. Select the following in the CR2 register:
   - Set OC1E bit: the OCMP1 pin is then dedicated to the output compare 1 function.
   - Set the PWM bit.
   - Select the timer clock (CC[1:0]) (see *Table 50*).

SPI Data I/O Register (SPIDR)

SPIDR Reset value: undefined

7	6	5	4	3	2	1	0
D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

The SPIDR register is used to transmit and receive data on the serial bus. In a master device, a write to this register will initiate transmission/reception of another byte.

Note: During the last clock cycle the SPIF bit is set, a copy of the received data byte in the shift register is moved to a buffer. When the user reads the serial peripheral data I/O register, the buffer is actually being read.

While the SPIF bit is set, all writes to the SPIDR register are inhibited until the SPICSR register is read.

Warning: A write to the SPIDR register places data directly into the shift register for transmission.

A read to the SPIDR register returns the value located in the buffer and not the content of the shift register (see *Figure 48*).

Table 58. SPI register map and reset values

Address (Hex.)	Register label	7	6	5	4	3	2	1	0
0021h	SPIDR Reset value	MSB x	x	x	x	x	x	x	LSB x
0022h	SPICR Reset value	SPIE 0	SPE 0	SPR2 0	MSTR 0	CPOL x	CPHA x	SPR1 x	SPR0 x
0023h	SPICSR Reset value	SPIF 0	WCOL 0	OVR 0	MODF 0	0	SOD 0	SSM 0	SSI 0

Even parity

The parity bit is calculated to obtain an even number of ‘1’s inside the frame made of the 7 or 8 LSB bits (depending on whether M is equal to 0 or 1) and the parity bit, for example, data = 00110101; 4 bits set => Parity bit will be 0 if Even parity is selected (PS bit = 0).

Odd parity

The parity bit is calculated to obtain an odd number of ‘1’s inside the frame made of the 7 or 8 LSB bits (depending on whether M is equal to 0 or 1) and the parity bit, for example, data = 00110101; 4 bits set => Parity bit will be 1 if Odd parity is selected (PS bit = 1).

Transmission mode

If the PCE bit is set then the MSB bit of the data written in the data register is not transmitted but is changed by the parity bit.

Reception mode

If the PCE bit is set then the interface checks if the received data byte has an even number of ‘1’s if even parity is selected (PS = 0) or an odd number of ‘1’s if odd parity is selected (PS = 1). If the parity check fails, the PE flag is set in the SCISR register and an interrupt is generated if PIE is set in the SCICR1 register.

SCI clock tolerance

During reception, each bit is sampled 16 times. The majority of the 8th, 9th and 10th samples is considered as the bit value. For a valid bit detection, all the three samples should have the same value otherwise the noise flag (NF) is set. For example: If the 8th, 9th and 10th samples are 0, 1 and 1 respectively, then the bit value will be ‘1’, but the Noise flag bit is set because the three samples values are not the same.

Consequently, the bit length must be long enough so that the 8th, 9th and 10th samples have the desired bit value. This means the clock frequency should not vary more than 6/16 (37.5%) within one bit. The sampling clock is resynchronized at each start bit, so that when receiving 10 bits (one start bit, 1 data byte, 1 stop bit), the clock deviation must not exceed 3.75%.

Note: The internal sampling clock of the microcontroller samples the pin value on every falling edge. Therefore, the internal sampling clock and the time the application expects the sampling to take place may be out of sync. For example: If the baud rate is 15.625 kbaud (bit length is 64µs), then the 8th, 9th and 10th samples will be at 28µs, 32µs and 36µs respectively (the first sample starting ideally at 0µs). But if the falling edge of the internal clock occurs just before the pin value changes, the samples would then be out of sync by ~4µs. This means the entire bit length must be at least 40µs (36µs for the 10th sample + 4µs for synchronization with the internal sampling clock).

Table 64. SCICR2 register description (continued)

Bit	Name	Function
5	RIE	Receiver interrupt Enable This bit is set and cleared by software. 0: Interrupt is inhibited 1: An SCI interrupt is generated whenever OR = 1 or RDRF = 1 in the SCISR register.
4	ILIE	Idle Line Interrupt Enable This bit is set and cleared by software. 0: Interrupt is inhibited 1: An SCI interrupt is generated whenever IDLE = 1 in the SCISR register.
3	TE	Transmitter Enable This bit enables the transmitter. It is set and cleared by software. 0: Transmitter is disabled 1: Transmitter is enabled *Notes:* *- During transmission, a '0' pulse on the TE bit ('0' followed by '1') sends a preamble (Idle line) after the current word.* *- When TE is set there is a 1 bit-time delay before the transmission starts.* **Caution:** The TDO pin is free for general purpose I/O only when the TE and RE bits are both cleared (or if TE is never set).
2	RE	Receiver Enable This bit enables the receiver. It is set and cleared by software. 0: Receiver is disabled 1: Receiver is enabled and begins searching for a start bit *Note: Before selecting Mute mode (setting the RWU bit), the SCI must first receive some data, otherwise it cannot function in Mute mode with Wake-Up by Idle line detection.*
1	RWU	Receiver Wake-Up This bit determines if the SCI is in mute mode or not. It is set and cleared by software and can be cleared by hardware when a wake-up sequence is recognized. 0: Receiver in Active mode 1: Receiver in Mute mode
0	SBK	Send Break This bit set is used to send break characters. It is set and cleared by software. 0: No break character is transmitted. 1: Break characters are transmitted. *Note: If the SBK bit is set to '1' and then to '0', the transmitter will send a Break word at the end of the current word.*

Using a prebyte

The instructions are described with one to four opcodes.

In order to extend the number of available opcodes for an 8-bit CPU (256 opcodes), three different prebyte opcodes are defined. These prebytes modify the meaning of the instruction they precede.

The whole instruction becomes:

PC-2 End of previous instruction

PC-1 Prebyte

PC Opcode

PC+1 Additional word (0 to 2) according to the number of bytes required to compute the effective address

These prebytes enable the instruction in Y as well as indirect addressing modes to be implemented. They precede the opcode of the instruction in X or the instruction using direct addressing mode. The prebytes are:

PDY 90 Replace an X based instruction using immediate, direct, indexed, or inherent addressing mode by a Y one.

PIX 92 Replace an instruction using direct, direct bit, or direct relative addressing mode to an instruction using the corresponding indirect addressing mode.
It also changes an instruction using X indexed addressing mode to an instruction using indirect X indexed addressing mode.

PIY 91 Replace an instruction using X indirect indexed addressing mode by a Y one.

12.6.3 Crystal and ceramic resonator oscillators

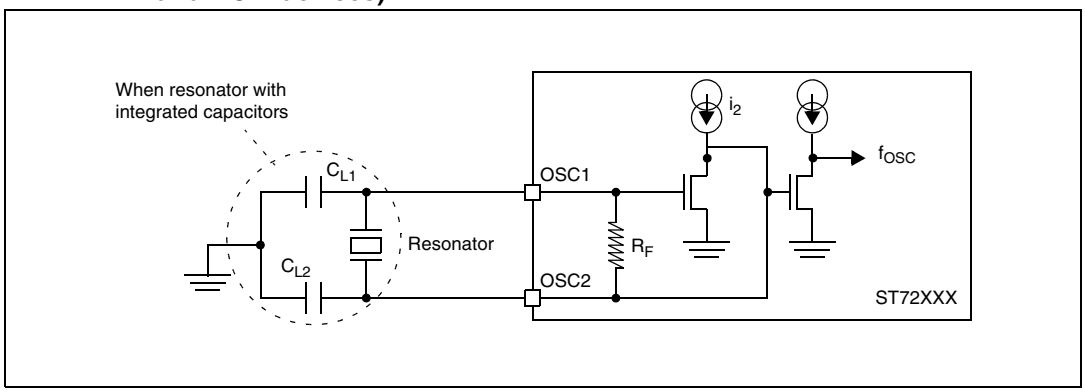
The ST7 internal clock can be supplied with four different crystal/ceramic resonator oscillators. All the information given in this paragraph are based on characterization results with specified typical external components. In the application, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and start-up stabilization time. Refer to the crystal/ceramic resonator manufacturer for more details (frequency, package, accuracy...).

Table 95. Crystal and ceramic resonator oscillators

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f_{OSC}	Oscillator frequency(1)	LP: low power oscillator MP: medium power oscillator MS: medium speed oscillator HS: high speed oscillator	1 >2 >4 >8		2 4 8 16	MHz
R_F	Feedback resistor(2)		20		40	kΩ
C_{L1} C_{L2}	Recommended load capacitance versus equivalent serial resistance of the crystal or ceramic resonator (R_S)(3)	R_S = 200Ω LP oscillator R_S = 200Ω MP oscillator R_S = 200Ω MS oscillator R_S = 100Ω HS oscillator	22 22 18 15		56 46 33 33	pF
i_2	OSC2 driving current	V_{DD} = 5V, V_{IN} = V_{SS} LP oscillator MP oscillator MS oscillator HS oscillator		80 160 310 610	150 250 460 910	µA

1. The oscillator selection can be optimized in terms of supply current using an high quality resonator with small R_S value. Refer to crystal/ceramic resonator manufacturer for more details.
2. Data based on characterization results, not tested in production. The relatively low value of the RF resistor, offers a good protection against issues resulting from use in a humid environment, due to the induced leakage and the bias condition change. However, it is recommended to take this point into account if the microcontroller is used in tough humidity conditions.
3. For C_{L1} and C_{L2} it is recommended to use high-quality ceramic capacitors in the 5pF to 25pF range (typ.) designed for high-frequency applications and selected to match the requirements of the crystal or resonator. C_{L1} and C_{L2}, are usually the same size. The crystal manufacturer typically specifies a load capacitance which is the series combination of C_{L1} and C_{L2}. PCB and MCU pin capacitance must be included when sizing C_{L1} and C_{L2} (10 pF can be used as a rough estimate of the combined pin and board capacitance).

Figure 64. Typical application with a crystal or ceramic resonator (8/16 Kbyte Flash and ROM devices)



2. Not tested in production.

12.8.3 Absolute maximum ratings (electrical sensitivity)

Based on three different tests (ESD, LU and DLU) using specific measurement methods, the product is stressed in order to determine its performance in terms of electrical sensitivity. For more details, refer to the application note AN1181.

Electrostatic discharge (ESD)

Electrostatic discharges (a positive then a negative pulse separated by 1 second) are applied to the pins of each sample according to each pin combination. The sample size depends on the number of supply pins in the device (3 parts*(n+1) supply pin). Two models can be simulated for standard microcontrollers: Human Body Model and Charged Device Model. These tests conform to standards JESD22-A114 and JESD22-C101. There is an additional model for automotive microcontrollers: Machine Model, JESD22-A115.

Table 103. Absolute maximum ratings

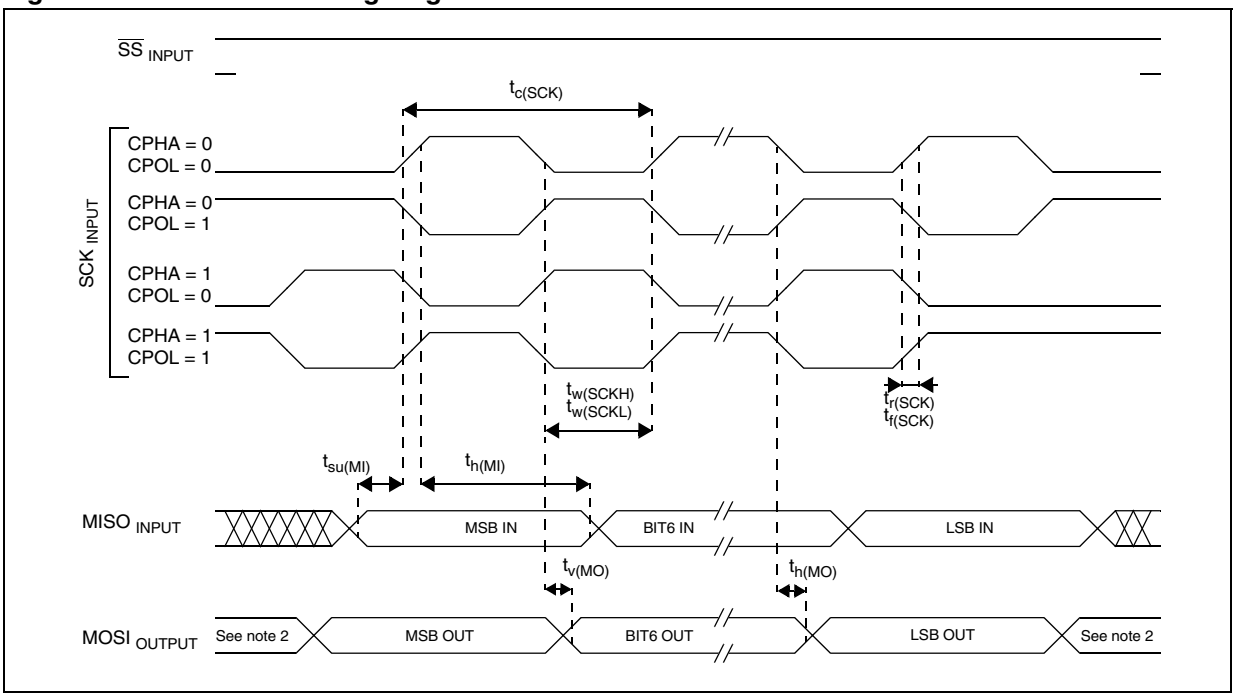
Symbol	Ratings	Conditions	Maximum value(1)	Unit
$V_{ESD(HBM)}$	Electrostatic discharge voltage (human body model)	T_A = +25°C	2000	V
$V_{ESD(MM)}$	Electrostatic discharge voltage (machine model)		200	
$V_{ESD(CDM)}$	Electrostatic discharge voltage (charged device model)		750	

1. Data based on characterization results, not tested in production.

Static and dynamic Latch-Up

- **LU**: 3 complementary static tests are required on 10 parts to assess the latch-up performance. A supply overvoltage (applied to each power supply pin) and a current injection (applied to each input, output and configurable I/O pin) are performed on each sample. This test conforms to the EIA/JESD 78 IC latch-up standard. For more details, refer to the application note AN1181.
- **DLU**: Electrostatic discharges (one positive then one negative test) are applied to each pin of three samples when the micro is running to assess the latch-up performance in dynamic mode. Power supplies are set to the typical values, the oscillator is connected as near as possible to the pins of the micro and the component is put in reset mode. This test conforms to the IEC1000-4-2 and SAEJ1752/3 standards. For more details, refer to the application note AN1181.

Figure 81. SPI master timing diagram(1)



1. Measurement points are done at CMOS levels: $0.3xV_{DD}$ and $0.7xV_{DD}$.
2. When no communication is on-going the data output line of the SPI (MOSI in master mode, MISO in slave mode) has its alternate function capability released. In this case, the pin status depends on the I/O port configuration.

12.13 10-bit ADC characteristics

Subject to general operating conditions for V_{DD}, f_{CPU}, and T_A unless otherwise specified.

Table 111. 10-bit ADC characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f_{ADC}	ADC clock frequency		0.4		2	MHz
V_{AREF}	Analog reference voltage	$0.7*V_{DD} \le V_{AREF} \le V_{DD}$	3.8		V_{DD}	V
V_{AIN}	Conversion voltage range(1)		V_{SSA}		V_{AREF}	
I_{lkg}	Input leakage current for analog input(2)	$-40°C \le T_A \le +85°C$			±250	nA
		Other T_A ranges			±1	µA
R_{AIN}	External input impedance				See *Figure 82* and *Figure 83*	kΩ
C_{AIN}	External capacitor on analog input					pF
f_{AIN}	Variation freq. of analog input signal					Hz
C_{ADC}	Internal sample and hold capacitor			12		pF